

High-Voltage Reverse-Input-Capable 4-20mA **Current Loop Protector**

General Description

The MAX14626 current loop protector features a currentlimit switch to prevent damage to the sensor devices due to faulty current loop conditions. The current-limit switch features a 25Ω (typ) on-resistance and operates from a +2.3V to +36V input voltage range. The accurate current limit is set to 30mA, making the part ideal for protecting the sensor reading devices.

The MAX14626 handles an overcurrent event in a continuous current-limit mode. Additional safety features include thermal shutdown to prevent overheating and reverse-input blocking to protect from being reverse connected into the sensor.

The device is available in a tiny 6-pin (3mm x 3mm), TDFN exposed pad package and is specified over the -40°C to +85°C extended temperature range.

Applications

Industrial Current Loop Control

Benefits and Features

♦ High Performance

Low On-Resistance 25 Ω (typ) Accurate ±10% Current Limit +2.3V to +40V Wide Supply Voltage Range **Low Operating Current Ultra-Low Temperature Coefficient**

♦ Robust Protection for Sensors

Avoids Power Dissipation Issues Compared to Discrete Solutions Thermal Shutdown

Reverse Input Protection

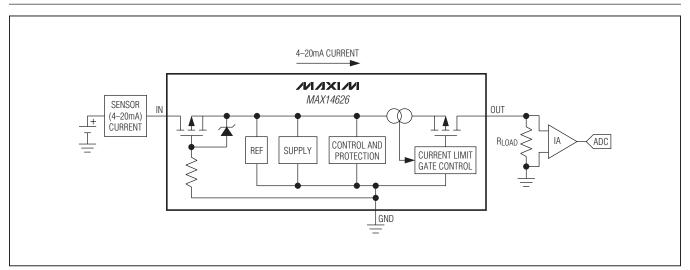
♦ Saves Space in Compact Systems

Eliminates Need for Discrete PTC Poly Switch, **Zener Diodes, and Resistors** 3mm x 3mm, 6-Pin TDFN Package

Ordering Information appears at end of data sheet.

For related parts and recommended products to use with this part, refer to www.maxim-ic.com/MAX14626.related.

Typical Operating Circuit



High-Voltage Reverse-Input-Capable 4-20mA **Current Loop Protector**

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)		Operating Temperature Range40°C to +125°C
IN to GND40V to	+40V	Maximum Junction Temperature+150°C
OUT to GND0.3V to	+40V	Storage Temperature Range65°C to +150°C
Current into IN Internally Li	.imited	Lead Temperature (soldering, 10s)+300°C
Current into OUT1	00mA	Soldering Temperature (reflow)+260°C
Continuous Power Dissipation (T _A = +70°C)		
TDFN (derate 23.8mW/°C above +70°C)1904	1.8mW	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 1)

Junction-to-Ambient Thermal Resistance (θ_{JA}).............. 42°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a fourlayer board. For detailed information on package thermal considerations, refer to www.maxim-ic.com/thermal-tutorial.

DC ELECTRICAL CHARACTERISTICS

 $(I_{IN} = 50\mu\text{A to } 24\text{mA}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, R_{LOAD} = 25\Omega \text{ to } 1\text{k}\Omega, \text{ unless otherwise noted.}$ Typical values are at $I_{IN} = 10\text{mA}, R_{LOAD} = 25\Omega \text{ to } 1\text{k}\Omega$ = 250Ω , and $T_A = +25$ °C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SUPPLY VOLTAGE	,			-	-	
Operating Start Voltage	V _{IN_ST}	$I_{IN} = 20\mu A$			2.3	V
Operating IN Voltage	V _{IN}				36	V
Operating IN to OUT Drop Voltage		I _{IN} = 24mA			2.8	V
Quiescent Current (Normal Mode: 4-20mA)	IQ	$R_{LOAD} \le 250\Omega$		40	56	μΑ
Quiescent Current (Current- Limit Mode: Current > 25mA)	IQ	$I_{OUT} = 30$ mA, $V_{IN} = 5$ V, $R_{LOAD} = 25\Omega$			65	μΑ
Reverse Current	I _{REV}	V _{IN} = -36V, V _{OUT} = 0V, current into OUT		0.01	0.3	μΑ
IN to OUT Switch On-Resistance	R _{ON}	V _{IN} = 4V, I _{OUT} = 16mA		25	45	Ω
Forward Current Limit	I _{LIM}	V _{IN} = 36V	27	30	33	mA
DYNAMIC						
Turn-On Time	t _{SS}	V_{IN} = 3V, time from V_{IN} applied to V_{OUT} = 90% of V_{IN} (Note 3)		10		μs
Turn-Off Time	toff	Time from thermal shutdown (Note 3)		20		μs
Current-Limit Reaction Time	t _{LIM}	Input current source from 20mA to 50mA (Note 4)	50		μs	
Current-Limit Overshoot Voltage		Input current source from 0mA to 50mA		50		%
Input Small Signal Bandwidth	BW	$2mA \leq DC~I_{IN} \leq 24mA,~\Delta I_{IN} = 1mA_{P\text{-}P}$ at $1k\Omega$	> 10		kHz	

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DC ELECTRICAL CHARACTERISTICS (continued)

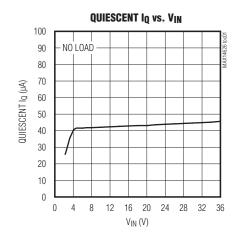
 $(I_{IN}=50\mu\text{A to 24mA}, T_{A}=-40^{\circ}\text{C to }+85^{\circ}\text{C}, R_{LOAD}=25\Omega \text{ to }1\text{k}\Omega, \text{ unless otherwise noted.}$ Typical values are at $I_{IN}=10\text{mA}, R_{LOAD}=10\text{mA}$ = 250Ω , and $T_A = +25$ °C.) (Note 2)

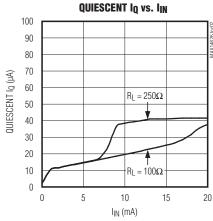
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
THERMAL PROTECTION						
Thermal Shutdown				+150		°C
Thermal-Shutdown Hysteresis				20		°C

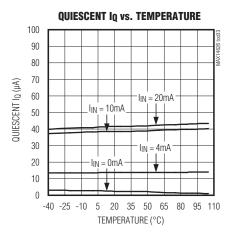
- Note 2: All devices are 100% production tested at $T_A = +25^{\circ}C$, unless otherwise noted. Limits over the -40°C to +85°C operating temperature range are guaranteed by design.
- Note 3: Turn-on time and turn-off time are defined as the difference in the time between when the output voltage crosses 10% and 90% of the final output voltage.
- Note 4: Input current source can support voltage up to +40V (absolute maximum). Current reaction time is defined as the settling time of the output current after a fault event.

Typical Operating Characteristics

 $(V_{IN} = 24V, I_{IN} = 10 \text{mA}, R_{I,OAD} = 250\Omega$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C.}$)



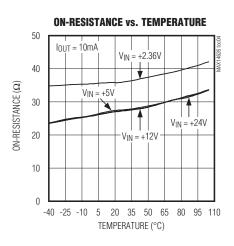


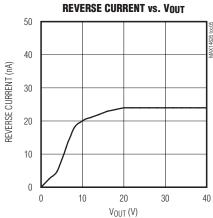


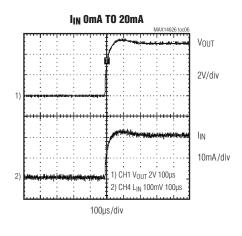
High-Voltage Reverse-Input-Capable 4-20mA **Current Loop Protector**

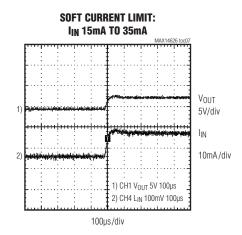
Typical Operating Characteristics (continued)

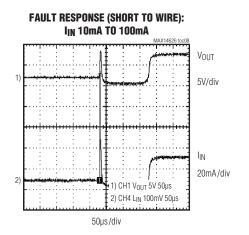
 $(V_{IN}=24V, I_{IN}=10mA, R_{LOAD}=250\Omega, unless otherwise noted. Typical values are at T_A=+25°C.)$





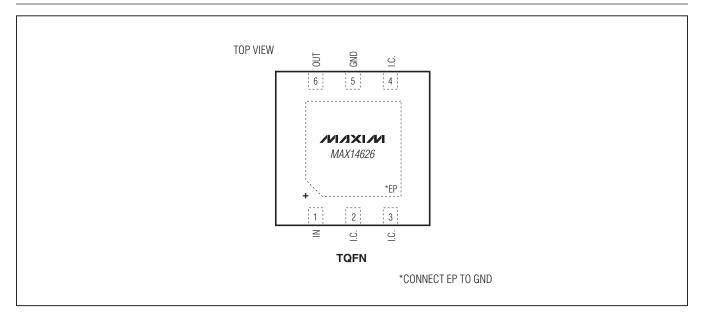






High-Voltage Reverse-Input-Capable 4-20mA **Current Loop Protector**

Pin Configuration

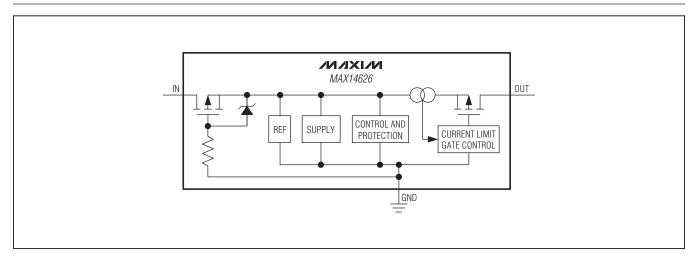


Pin Description

PIN	NAME	FUNCTION
1	IN	Power Input
2, 3, 4	I.C.	Internally Connected. Connect I.C. to GND.
5	GND	Ground
6	OUT	Switch Output
_	EP	Exposed Pad. Connect EP to GND. Connect to a large ground plane to maximize thermal performance. Not intended as an electrical connection point.

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Functional Diagram



Detailed Description

The MAX14626 current loop protector features a currentlimit switch to prevent damage to the sensor devices due to faulty current loop conditions. The current-limit switch features a 25Ω (typ) on-resistance and operates from a +2.3V to +36V input voltage range. The accurate current limit is set to 30mA, making the part ideal for protecting the sensor reading devices.

The MAX14626 handles an overcurrent event in a continuous current-limit mode. Additional safety features include thermal shutdown to prevent overheating and reverse input blocking to protect from being reverse connected into the sensor.

Reverse Input Protection

The device features reverse input protection to protect the downstream sensor. When a reverse input voltage is detected, control circuitry turns off the internal FET and isolates the output from the input.

Thermal Shutdown

The device enters thermal shutdown when the die temperature exceeds +150°C (typ). In thermal shutdown, the internal FETs are turned off. When the die temperature drops by 20°C, the device turns back on automatically.

Applications Information

Figure 1 shows the device in a 4-20mA current loop sensor application.

Exposed Pad and Layout Concerns

Connect the exposed pad to a large ground plane to maximize thermal performance. The exposed pad is not intended as an electrical connection point.

To optimize the switch response time to output shortcircuit conditions, it is very important to keep all traces as short as possible to reduce the effect of undesirable parasitic inductance.

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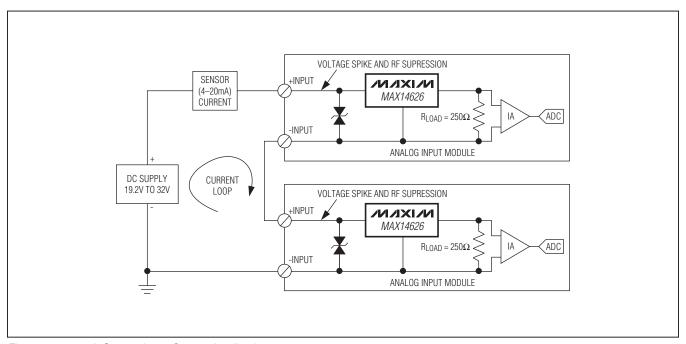


Figure 1. 4–20mA Current Loop Sensor Application

Ordering Information

PART	TEMP	PIN-	TOP
	RANGE	PACKAGE	MARK
MAX14626ETT+T	-40°C to +85°C	6 TDFN-EP*	AVF

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

PROCESS: BICMOS

Chip Information

Package Information

For the latest package outline information and land patterns (footprints), go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	DOCUMENT	LAND
TYPE	CODE	NO.	PATTERN
6 TDFN	T633+2	21-0137	

T = Tape and reel.

^{*}EP = Exposed pad.

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	
0	3/12	Initial release	_

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